IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Keiichiro KATA et al.

Title: PROCESS FOR MANUFACTURING

SEMICONDUCTOR DEVICE AND

SEMICONDUCTOR WAFER

Appl. No.: **REISSUE** of 5,844,304 filed

September 25, 1995

Examiner: TBD

Art Unit: TBD

INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §1.56

Commissioner for Patents Box REISSUE Washington, D.C. 20231

Sir:

Submitted herewith on Form PTO/SB/08 is a listing of documents known to Applicants in order to comply with Applicants' duty of disclosure pursuant to 37 C.F.R. § 1.56. A copy of each listed document is being submitted to comply with the provisions of 37 C.F.R. § 1.97 and § 1.98.

The submission of any document herewith, which is not a statutory bar, is not intended as an admission that such document constitutes prior art against the claims of the present application or that such document is considered material to patentability as defined in 37 CFR §1.56(b). Applicants do not waive any rights to take any action which would be appropriate to antedate or otherwise remove as a competent reference any document which is determined to be a *prima facie* art reference against the claims of the present application.

TIMING OF THE DISCLOSURE

The listed documents are being submitted in compliance with 37 CFR § 1.97(b), within three (3) months of the filing date of the application.

RELEVANCE OF EACH DOCUMENT

An English translation of the foreign-language document 3 is not readily available. However, the absence of such translation does not relieve the PTO from its duty to consider the submitted foreign language document (37 CFR § 1.98 and MPEP § 608). English abstracts are attached for document 3. However, the English abstract from www.delphion.com was provided to applicants by a third party, and thus applicants do not attest to the veracity of this abstract. This document relates to "Electrolytic Plating for Bump Electrode for Integrated Circuit Device".

An English translation of the foreign-language document 4 is provided. This English translation, however, was provided to applicants by a third party, and applicants thus do not attest to the veracity of the translation. However, the absence of such verified translation does not relieve the PTO from its duty to consider the submitted foreign language document (37 CFR § 1.98 and MPEP § 608). English abstracts are also attached for document 4. This document relates to "Method for Manufacturing Semiconductor Device".

Applicants respectfully request that any listed document be considered by the Examiner and be made of record in the present application and that an initialed copy of Form PTO/SB/08 be returned in accordance with MPEP § 609.

The Commissioner is hereby authorized to charge any additional fees which may be required regarding this application under 37 CFR §§ 1.16-1.17, or credit any overpayment, to Deposit Account No. 19-0741. Should no proper payment be enclosed herewith, as by a check being in the wrong amount, unsigned, post-dated, otherwise improper or informal or even entirely missing, the Commissioner is authorized to charge the unpaid amount to Deposit Account No. 19-0741.

Respectfully submitted,

FOLEY & LARDNER Customer Number: 22428

Jstomer Number. 22

22428

PATENT TRADEMARK OFFICE

Telephone: (202) 672-5403 Facsimile: (202) 672-5399 John J. Feldhaus

Attorney for Applicant Registration No. 28,822

MODIFIED PTO/SB/08 (08-00) Approved for us through 10/31/2002. OMB 0651-0031

U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control

number.	Substitute for form	1449B/	PTO	Complete if Known		
-	NFORMATION DISTATEMENT BY			Application Numb r	Reissue of 5,844,304 issued December 1, 1998	
	2 4 2 1			Filing Date		
	Date Submi	itted:	met 22 2003	First Named Inventor	Keiichiro Kata	
		Au	gast 22, 200J	Group Art Unit	2503 (suggested)	
Sheet	1	of	1	Attorney Docket Number	069974-0143	

				U.S. PA	TENT DOCUMENTS	3		
Examiner Initials*	Cite No.1	U.S. Patent Document Kind Number Code² (if		Name of Patentee or Applicant of Cited Document		Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	
	1	2 760 220	known)	Hamer et al		09/18/1973		
	2	3,760,238 5,289,038	 	Amano		02/22/1994		
				FOREIGN	PATENT DOCUMEN	JTS.		
	Ι					Date of Publication of	Pages, Columns, Lines,	T^-
Examiner Initials*	Cite No. ¹			le ⁵ Applica	me of Patentee or nt of Cited Documents	Cited Document MM-DD-YYYY	Where Relevant Passages or Relevant Figures Appear] 7
	3	JP 05-121	413	Hisashi		05/18/1993		T
	4	JP 52-087	983	Miyamo	oto	07/22/1977		\top
								\pm
				NON PATENT	LITERATURE DOCUM	MENTS		
Examiner Initials*	Cite No.1			rnal, serial, sy		of the article (when appretc.) date, page(s), volumere published.		7
				1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 -			<u> </u>	
	ł				·i .			

Examiner	Date
Signature	Considered

Burden Hour Statement: This form is estimated to take 2.0 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, PO Box 1450, Alexandria, Virginia 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, PO Box 1450, Alexandria, Virginia 22313-1450.

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

¹ Unique citation designation number. ²See attached Kinds of U.S. Patent Documents. ³Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). ¹For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁴Applicant is to place a check mark here if English language Translation is attached.